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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/587,237	07/26/2006	Yasuyuki Arai	0756-7783	8563
	7590 06/28/201 ectual Property Law O	EXAMINER		
3975 Fair Ridge Drive Suite 20 North Fairfax, VA 22033			KOLAHDOUZAN, HAJAR	
			ART UNIT	PAPER NUMBER
ŕ			2893	
			MAIL DATE	DELIVERY MODE
			06/28/2010	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)	
10/587,237	ARAI ET AL.	
Examiner	Art Unit	

The MAILING DATE of this communication appears on	the cover sheet with the correspondence address
THE REPLY FILED <u>17 June 2010</u> FAILS TO PLACE THIS APPLICAT	ION IN CONDITION FOR ALLOWANCE.
1.  The reply was filed after a final rejection, but prior to or on the sar application, applicant must timely file one of the following replies: application in condition for allowance; (2) a Notice of Appeal (with for Continued Examination (RCE) in compliance with 37 CFR 1.1 periods:	(1) an amendment, affidavit, or other evidence, which places the appeal fee) in compliance with 37 CFR 41.31; or (3) a Request
The period for reply expiresmonths from the mailing date of	the final rejection.
b) The period for reply expires on: (1) the mailing date of this Advisory no event, however, will the statutory period for reply expire later than	Action, or (2) the date set forth in the final rejection, whichever is later. In
Extensions of time may be obtained under 37 CFR 1.136(a). The date on which have been filed is the date for purposes of determining the period of extension a under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the shortene set forth in (b) above, if checked. Any reply received by the Office later than thr may reduce any earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL	and the corresponding amount of the fee. The appropriate extension fee d statutory period for reply originally set in the final Office action; or (2) as
<ol> <li>The Notice of Appeal was filed on A brief in compliance of filing the Notice of Appeal (37 CFR 41.37(a)), or any extension the Notice of Appeal has been filed, any reply must be filed within the AMENDMENTS</li> </ol>	nereof (37 CFR 41.37(e)), to avoid dismissal of the appeal. Since a
3. The proposed amendment(s) filed after a final rejection, but prio	r to the date of filing a brief, will not be entered because
a) ∑ The proposed amendment(s) flied after a final rejection, but pro (a) ∑ They raise new issues that would require further considera	
(b) They raise the issue of new matter (see NOTE below);	tion and/or scaron (see No 12 sciew),
(c) They are not deemed to place the application in better form appeal; and/or	n for appeal by materially reducing or simplifying the issues for
(d) ☐ They present additional claims without canceling a corresp	onding number of finally rejected claims.
NOTE: See Continuation Sheet. (See 37 CFR 1.116 and	41.33(a)).
4. $\square$ The amendments are not in compliance with 37 CFR 1.121. See	attached Notice of Non-Compliant Amendment (PTOL-324).
5. Applicant's reply has overcome the following rejection(s):	,
non-allowable claim(s).	if submitted in a separate, timely filed amendment canceling the
7.  For purposes of appeal, the proposed amendment(s): a)  will how the new or amended claims would be rejected is provided be The status of the claim(s) is (or will be) as follows: Claim(s) allowed: Claim(s) objected to: Claim(s) rejected: 1-12. Claim(s) withdrawn from consideration:	
AFFIDAVIT OR OTHER EVIDENCE	
<ol> <li>The affidavit or other evidence filed after a final action, but before because applicant failed to provide a showing of good and suffici was not earlier presented. See 37 CFR 1.116(e).</li> </ol>	
9. The affidavit or other evidence filed after the date of filing a Notic entered because the affidavit or other evidence failed to overcom showing a good and sufficient reasons why it is necessary and w	ne <u>all</u> rejections under appeal and/or appellant fails to provide a
10. ☐ The affidavit or other evidence is entered. An explanation of the	status of the claims after entry is below or attached.
REQUEST FOR RECONSIDERATION/OTHER	
<ol> <li>The request for reconsideration has been considered but does I <u>See Continuation Sheet.</u></li> </ol>	NOT place the application in condition for allowance because:
<ul><li>12. ☐ Note the attached Information <i>Disclosure Statement</i>(s). (PTO/S</li><li>13. ☐ Other:</li></ul>	B/08) Paper No(s)
/Davienne Monbleau/	/HAJAR KOLAHDOUZAN/
Supervisory Patent Examiner, Art Unit 2893	Examiner, Art Unit 2893

Continuation of 3. NOTE: New limitations:

claim 1 and 9 recite "an adhesive" and that "the first sealing film is attached to the substrate with the adhesive".

claims 2, 3, and 7 recite "a first adhesive; a second adhesive " and that the first sealing film is attached to the substrate with the first adhesive" and "the second sealing film is attached to the substrate provided with the first adhecive, the first sealing film, and the integrated circuit with the second adhecive" which are new limitations and need further search.

Continuation of 11. does NOT place the application in condition for allowance because:

Although the amended claims bring new limitations that were never recited in any of the claims before, the amended claims would still be rejectable by the same references as shown in the Final rejection.

Regarding claims 1 and 9, Yamazaki (US 2003/0034497) teaches [Figs.1-2] having an adhesive [bottom 113] and also teaches that the first sealing film [114] is attached to the substrate [112] with the adhesive [113 is a bonding layer that sticks the substrate and sealing film together as shown in fig.2B].

Yamazaki also teaches a stack of the adhesive [113, the first sealing film [114], the integrated circuit [104], and the antenna [upper conductive bar that is connected to TFT 104] is covered with the second sealing film [111].

Regarding claims 2, 3, and 7, Yamazaki teaches [Figs.1-2] having a first adhesive [bottom 113] and a second adhesive [upper 113 which is not labeled in Fig.2B but shown as a same layer in the figure] and also teaches that the first sealing film [114] is attached to the substrate [112] with the first adhesive [bottom 113 is a bonding layer that sticks the substrate and sealing film together as shown in fig.2B].

Also Yamazaki [Fig.2B] teaches that the second sealing film [111]is attached to the substrate [112] provided with the first adhesive [bottom 113], the first sealing film [114] and the integrated circuit [104] with the second adhesive [upper 113].

/Davienne Monbleau/ SPE AU 2893